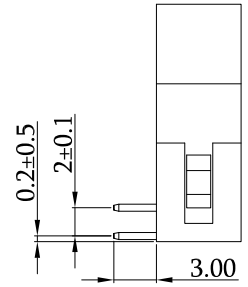


Recommended PCB Layout
(PCB TOLERANCE ±0.1)



1. MATERIAL

- 1.1 INSULATOR: POLYESTER (UL 94V-0); STANDARD: PA9T
- 1.2 CONTACT MATERIAL: COPPER ALLOY.
- 1.3 CONTACT PLATING: Au or Sn Over Ni

2. SPECIFICATION

- 2.1 CURRENT RATING: 2.0 Amp.
- 2.2 INSULATION RESISTANCE: 1000mΩ Min.
- 2.3 DIELECTRIC WITHSTANDING: 500VAC.
- 2.4 CONTACT RESISTENCE: 20mΩ Max.
- 2.5 OPERATING REMPERATURE: -40°C TO +105°C.

EH 200 - XXX - X X X GX

<u>Category</u> B=Box Header		<u>Plating Standard: G0</u> G0: Gold Flash G2: 1U" Gold G3: 3U" Gold G4: 5U" Gold G5: 10U" Gold G6: 15U" Gold Gold SN: Tin
<u>Pitch</u> 0.80=080 1.00=100 1.27=127 2.00=200 2.54=254		<u>Packing Style</u> 1. Tray 2. Tape & Reel 3. Tube
<u>No. of PINS</u> 2 x 05 ~ 2 x 32 PINS		<u>Insulator Material</u> 1: PBT 2: PA6T 3: PA9T 4: LCP
<u>Connector Type</u> S=Straight R=Right Angle M=SMT		

PRODUCT TITLE: 2.00mm Pitch Ejector Header, Right Angle, Thru-Hole	
UNLESS OTHERWISE SPECIFIED TOLERANCES	SCALE: 1/1 UNIT: mm
	SIZE: A3 PAGE: 1 OF 1 RAV.AOI EH200-2XX-RXXGX-08
DECIMALS: X :±0.5 X.X :±0.3 X.XX :±0.2 ANGLES: X :±6° X.X :±3° X.XX :±2°	WAYCONN ELECTRONICS